- **Ultrafast Operation . . . 7.6 ns (Typ)**
- **Low Positive Supply Current** 10.6 mA (Typ)
- Operates From a Single 5-V Supply or From a Split ±5-V Supply
- **Complementary Outputs**
- **Low Offset Voltage**
- No Minimum Slew Rate Requirement
- **Output Latch Capability**
- **Functional Replacement to the LT1016**

description

The TL3016 is an ultrafast comparator designed to interface directly to TTL logic while operating from either a single 5-V power supply or dual ±5-V supplies. It features extremely tight offset voltage and high gain for precision applications. It has complementary outputs that can be latched using the LATCH ENABLE terminal. Figure 1 shows the positive supply current of this comparator. The TL3016 only requires 10.6 mA (typical) to achieve a propagation delay of 7.6 ns.

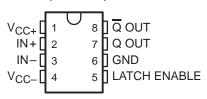
The TL3016 is a pin-for-pin functional replacement for the LT1016 comparator, offering higher speed operation but consuming half the power.

AVAILABLE OPTIONS

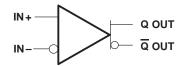
	PACKAG	CLUD		
TA	SMALL OUTLINE† (D)	TSSOP (PW)	CHIP FORM [‡] (Y)	
0°C to 70°C	TL3016CD	TL3016CPWLE	TL3016Y	
-40°C to 85°C	TL3016ID	TL3016IPWLE		

[†]The PW packages are available left-ended taped and reeled only. ‡ Chip forms are tested at $T_A = 25$ °C only.

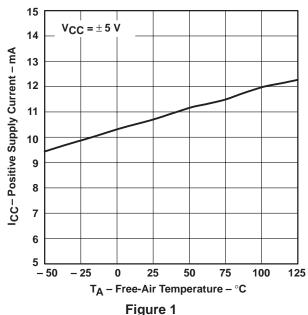
D AND PW PACKAGE (TOP VIEW)



symbol (each comparator)



POSITIVE SUPPLY CURRENT FREE-AIR TEMPERATURE





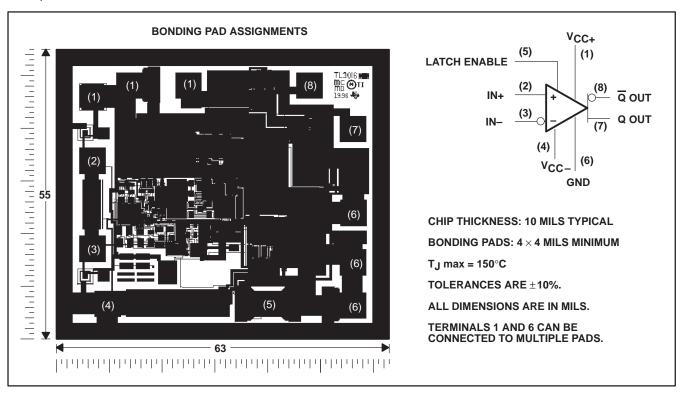


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



TL3016Y chip information

This chip displays characteristics similar to the TL3016C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.



COMPONENT COUNT				
Bipolars 53				
MOSFETs	49			
Resistors	46			
Capacitors	14			



TL3016, TL3016Y ULTRA-FAST LOW-POWER PRECISION COMPARATORS

SLCS130D - MARCH 1997 - REVISED MARCH 2000

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{DD} (see Note 1)	
Differential input voltage, V _{ID} (see Note 2)	
Input voltage range, V ₁	
Input voltage, V _I (LATCH ENABLE)	
Output current, IO	
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	–40°C to 85°C
Storage temperature range, T _{stq}	– 65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.

2. Differential voltages are at IN+ with respect to IN-.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW
PW	525 mW	4.2 mW/°C	336 mW



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

TL3016, TL3016Y ULTRA-FAST LOW-POWER PRECISION COMPARATORS

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electrical characteristics at specified operating free-air temperature, V_{DD} = ± 5 V, V_{LE} = 0 (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		TL3016C			TL3016I			UNIT	
	PARAWETER	TEST CONDI	IIONSI	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNII	
V _{IO} Input offset voltage		T _A = 25°C			0.5	3		0.5	3	mV	
VIO	input onset voltage	T _A = full range				3.5			3.5	IIIV	
ανιο	Temperature coefficient of input offset voltage				-4.8			-4.5		μV/°C	
li o	Input offset current	T _A = 25°C			0.1	0.6		0.1	0.6		
lio	Input offset current	T _A = full range				0.9			1.3	μΑ	
1.5	Input bias current	T _A = 25°C			6	10		6	10		
IB	input bias current	T _A = full range				10			10	μΑ	
\/.op	Common-mode input	$V_{DD} = \pm 5 \text{ V}$		-3.75		3.5	-3.75		3.5	V	
VICR	voltage range	V _{DD} = 5 V		1.25		3.5	1.25		3.5	v	
CMRR	Common-mode rejection ratio	$-3.75 \le V_{IC} \le 3.5 V$,	T _A = 25°C	80	97		80	97		dB	
, Supply-voltage rejection	Positive supply: 4.6 V ≤ T _A = 25°C	$\leq +V_{DD} \leq 5.4 \text{ V},$	60	72		60	72		dB		
ksvr	ratio	Negative supply: -7 V : $T_A = 25^{\circ}\text{C}$	$\leq -V_{DD} \leq -2 V$,	80	100		80	100		dB	
\/a:	Landard and and and	$I_{(sink)} = 4 \text{ mA},$ $T_A = 25^{\circ}C$	V+ ≤ 4.6 V,		500	600		500	600	mV	
VOL	Low-level output voltage	$I_{(sink)} = 10 \text{ mA},$ $T_A = 25^{\circ}\text{C}$	V+ ≤ 4.6 V,		750			750		IIIV	
\/-··	(Disk level autout value of	V+ ≤ 4.6 V, T _A = 25°C	$I_O = 1 \text{ mA},$	3.6	3.9		3.6	3.9		V	
VOH	High-level output voltage	V+ ≤ 4.6 V, T _A = 25°C	$I_{O} = 10 \text{ mA},$	3.4	3.7		3.4	3.7		V	
la a	Positive supply current	T full range			10.6	12.5		10.6	12.5	mA	
IDD	Negative supply current	T _A = full range		-1.8	-1.3		-2.4	-1.3		IIIA	
V _{IL}	Low-level input voltage (LATCH ENABLE)					0.8			0.8	V	
VIH	High-level input voltage (LATCH ENABLE)			2			2			V	
1	Low-level input current	V _{LE} = 0			0	1		0	1		
IIL	(LATCH ENABLE)	V _{LE} = 2 V			24	39		24	45	μΑ	

[†] Full range for the TL3016C is $T_A = 0^{\circ}$ C to 70° C. Full range for the TL3016I is $T_A = -40^{\circ}$ C to 85° C. ‡ All typical values are measures with $T_A = 25^{\circ}$ C.



switching characteristics, V_{DD} = ± 5 V, V_{LE} = 0 (unless otherwise noted)

PARAMETER		TEST SOUDITIONS!		TL3016C		TL3016I			UNIT	
	PARAMETER	TEST CON	T CONDITIONS MIN TYP MAX MIN TYP MAX		MAX] """ [
tod1 Propagation delay time‡	$\Delta V_{I} = 100 \text{ mV},$ $V_{OD} = 5 \text{ mV}$	T _A = 25°C		7.8	10		7.8	10		
		T _A = full range		7.8	11.2		7.8	12.2		
	$\Delta V_{I} = 100 \text{ mV},$	T _A = 25°C		7.6	10		7.6	10	ns	
		$V_{OD} = 20 \text{ mV}$	T _A = full range		7.6	11.2		7.6	12.2	
tsk(p)	Pulse skew (t _{pd+} - t _{pd} -)	$\Delta V_I = 100 \text{ mV},$ $T_A = 25^{\circ}\text{C}$	$V_{OD} = 5 \text{ mV},$		0.5			0.5		ns
t _{su}	Setup time, LATCH ENABLE				2.5			2.5		ns

TYPICAL CHARACTERISTICS

Table of Graphs

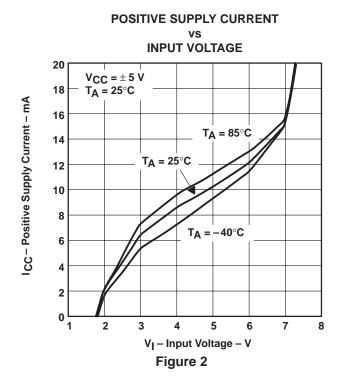
			FIGURE
		vs Input voltage	2
ICC	Positive supply current	vs Frequency	3
		vs Free-air temperature	4
ICC	Negative supply current	vs Free-air temperature	5
		vs Overdrive voltage	6
		vs Supply voltage	7
^t pd	Propagation delay time	vs Input impedance	8
		vs Load capacitance	9
		vs Free-air temperature	10
VIC	Common-mode input voltage	vs Free-air temperature	11
	Input threshold voltage (LATCH ENABLE)	vs Free-air temperature	12
V-	Output valtage	vs Output source current	13
VO	Output voltage	vs Output sink current	14
I _I	Input current (LATCH ENABLE)	vs Input voltage	15

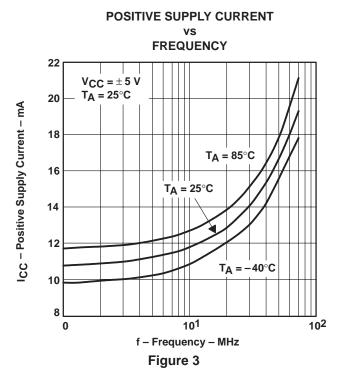


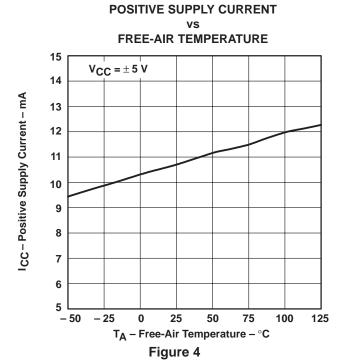
Full range for the TL3016C is 0°C to 70°C. Full range for the TL3016I is -40° C to 85°C.

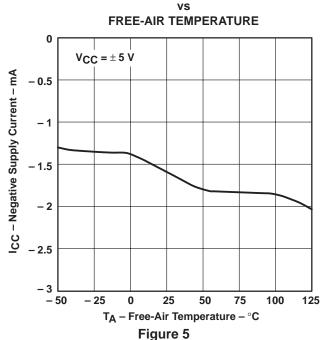
† tpd1 cannot be measured in automatic handling equipment with low values of overdrive. The TL3016 is 100% tested with a 1-V step and 500-mV overdrive at TA = 25°C only. Correlation tests have shown that tpd1 limits given can be ensured with this test, if additional dc tests are performed to ensure that all internal bias conditions are correct. For low overdrive conditions, Vos is added to the overdrive.

TYPICAL CHARACTERISTICS



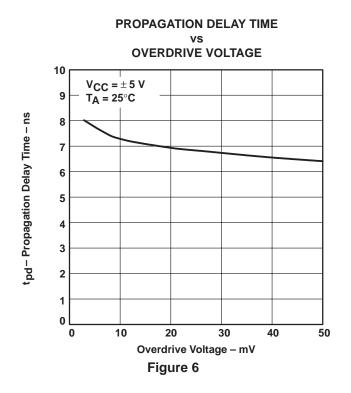


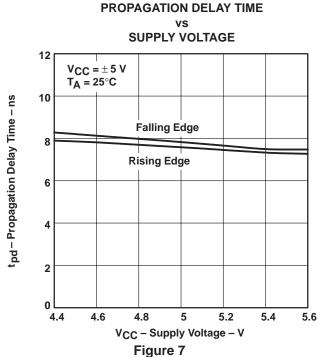


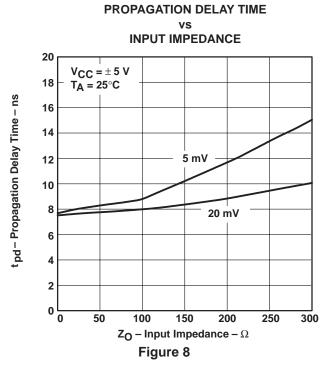


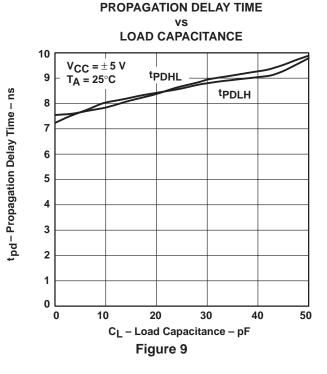
NEGATIVE SUPPLY CURRENT

TYPICAL CHARACTERISTICS



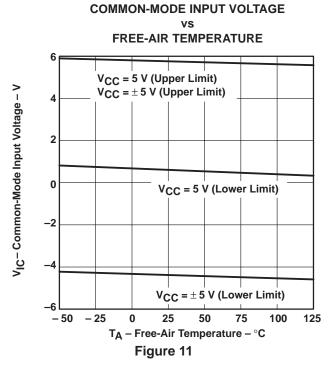






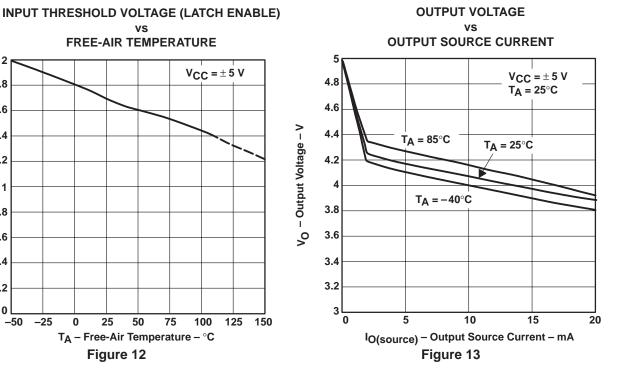
TYPICAL CHARACTERISTICS

PROPAGATION DELAY TIME FREE-AIR TEMPERATURE 25 V_{CC} = \pm 5 Vt pd - Propagation Delay Time - ns 20 15 Rising Edge 10 **Falling Edge** 5 - 50 - 25 25 50 75 100 125 T_A - Free-Air Temperature - °C Figure 10

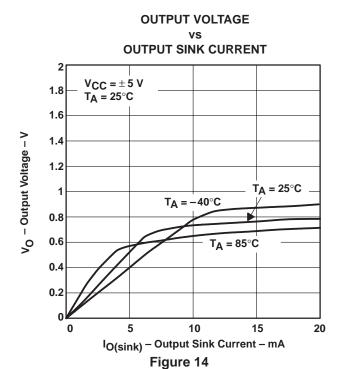


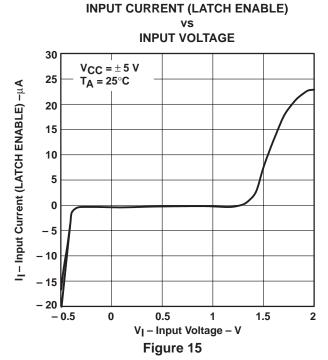
vs FREE-AIR TEMPERATURE V_{IT} – Input Threshold Voltage (LATCH ENABLE) – V $V_{CC} = \pm 5 V$ 1.8 1.6 1.4 1.2 1 0.8 0.6 0.4 0.2 -50 -25 25 50 75 100 125 TA - Free-Air Temperature - °C

Figure 12



TYPICAL CHARACTERISTICS



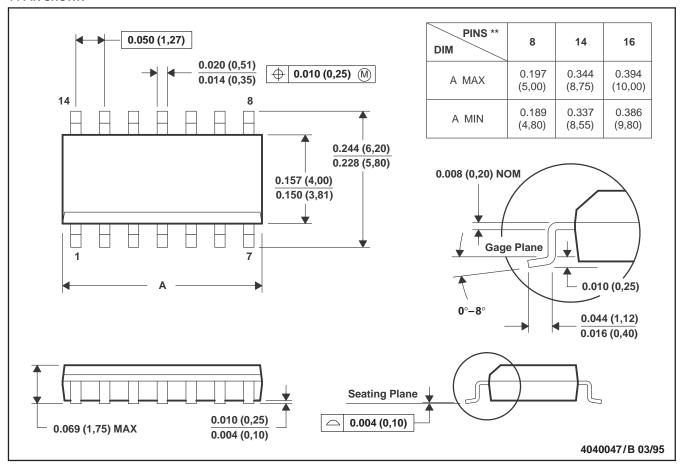


MECHANICAL INFORMATION

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

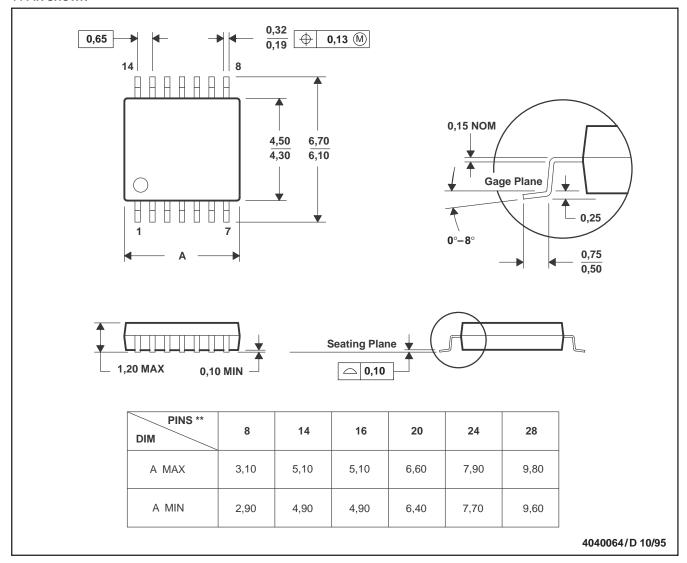
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Four center pins are connected to die mount pad.
- E. Falls within JEDEC MS-012

MECHANICAL INFORMATION

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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